



# MCP Specification 1.1

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# 1 What's New

Optional pin coordinates (relative to component origin) are added for alternative pin mapping method by coordinates mapping when pin name mapping fails.

## 2 Introduction

This document describes Sigrity Model Connection Protocol (MCP).

MCP is used for connecting circuit models and/or physical layouts among dies (chip), packages, and PCBs.

MCP allows automated model and structure connections within Sigrity products of any MCP models. It also allows third party tools to integrate or connect Sigrity models with MCP.

MCP uses a simple ASCII format that supports multiple circuits and pins for model connections and allows physical pins to be lumped in circuit models.

MCP is extensible and backward compatible.

### 3 MCP File Format

MCP is a block that is inserted into a host file as a comment section. It uses the host file's comment leading strings as its leading string.

The MCP block is case insensitive.

The MCP block contains one or more component connections.

The MCP block is described as follows. Here, \* is used as the example of the comment leading string used in SPICE circuits.

```
* [MCP Begin]
* [MCP Ver] 1.1
* [REM] comment till the end of the line
* [Structure Type] PKG
* [MCP Source] source
* [Coordinate Unit] unit
* [Connection] compName modelName totalNumberOfPins
* [Connection Type] DIE
* [Power Nets]
* pin cktnode net x y
* ...
* pin cktnode net x y
* [Ground Nets]
* pin cktnode net x y
* ...
* pin cktnode net x y
* [Signal Nets]
* pin cktnode net x y
* ...
* pin cktnode net x y
* [MCP End]
```

[MCP Begin] and [MCP End] mark the MCP block.

The contents of the MCP block are described below.

1. [MCP Ver] *1.1* is a one-line item. It specifies the version of MCP. It is a required item.
2. [REM] *comment* is the MCP comment. It is a one-line item. The comment can also be in the form from the host, except in the net list section. In the net list sections, the comment must be in the form of MCP comments.
3. [Structure Type] *PKG* specifies the type of the extracted circuit model. It is a one-line item. It is optional. It can be a combination of the following (delimited by spaces) DIE, PKG, PCB.
4. [MCP Source] *source* specifies the origin of the circuit model. It is a one-line item. It can include the tool name, the tool version, and/or the date the model was created. This item is optional.
5. [Coordinate Unit] *unit* defines the unit used by the coordinates. *unit* can be one of the following, m, cm, mm, um, nm, mil. The default is m. This item is optional.
6. [Connection] *compName modelName totalNumberOfPins* starts a component connection section in the MCP block. It is a one-line item. This item is required. An MCP block should contain at least one component connection section. In the item, *compName* is the name of the component connection (or circuit name in SPD file, or reference designator in common layout tools); *modelName* is the model definition name of the component connection (or part number in common layout tools); and the *totalNumberOfPins* is the number of pins in this component connection. A new [Connection] line ends the previous component connection section and starts a new component connection section.
7. [Connection Type] *DIE* specifies the type of the component connection. It is a one-line item. It is optional. It can be a combination of the following (delimited by spaces) DIE, PKG, PCB, VRM, or SINK.
8. [Power Nets] starts the power pin section of the component. It is a one-line item. It is optional.
9. *pin cktnode net x y* lists the information for a pin. *pin* is the name of the pin. *cktnode* is the circuit node name used in the extracted circuit corresponding to the pin. *net* is the net of the pin. *x y* are optional and are the relative coordinates of the pin relative to the component origin. The five fields should be in one line.
10. [Ground Nets] starts the ground pin section of the component. It is a one-line item. It is optional.
11. [Signal Nets] starts the signal pin section (ends the [Power Nets] or [Ground Nets] section if exists) of the component connection. It is a one-line item. It is optional.
12. In the Power/Ground/Signal pin sections, comments must be in the MCP comment form as \* [REM] *comment*.

## 4 MCP Samples

### 4.1 MCP in a Subcircuit

.subckt SigrityModel list\_of\_external\_nodes

\* The following is the MCP Section

\*\*\*\*\*

\* [MCP Begin]

\* [MCP Ver] 1.1

\* [MCP Source] Sigrity XtractIM 1.3.1 12/31/2007

\* [Coordinate Unit] um

\*

\*\*\*\*\*

\* The following is the info for component connection U1

\*\*\*\*\*

\* [Connection] U1 Si\_fc\_die\_3000 3000

\* [Connection Type] DIE

\* [REM]

\* [REM] -----Power Pin List of U1-----

\* [REM]

\* [Power Nets]

\* VDD01 CKT01 NET1 0 0

\* VDD02 CKT02 NET1 200 0

\* [REM]

\* [REM] -----Ground Pin List of U1-----

\* [REM]

\* [Ground Nets]

\* [REM] Pins of net NET2

\* VSS01 CKT03 NET2 100 0

\* VSS01 CKT04 NET2 300 0

\* ...

\* [REM]

\* [REM] -----Signal Pin List of U1-----

\* [REM]

\* [Signal Nets]



```
* SIG01   CKT05   NET3 500 300
* SIG01   CKT06   NET3 300 500
* ...
*
* [MCP End]
* This concludes the MCP section
```

- *Contents of the subckt*

```
.ends
```

## 4.2 MCP Sample 2

The following package extraction example uses net-based approach (vs. per pin model) where all the ground pins are lumped as one circuit node in each circuit connection.

```
.SUBCKT          psi_pkg_wb_pre-layout_032609_173742
+               die_1
+               die_6
+               die_3
+               die_4
+               BGA_VDD25
+               BGA_VDD125
+               BGA_1
+               BGA_2
+               die_GND1
+               die_GND1
+               die_GND1
+               die_GND1
+               BGA_GND2
+               BGA_GND2
+               BGA_GND2
+               BGA_GND2
```

\*The following is the Sigrity MCP(model connection protocol) Section

```
*****
```

```
*[MCP Begin]
```

```
*[MCP Ver] 1.0
```

```
*[MCP Source] Sigrity PowerSI 8.1.32 3/26/2009
```

```
*
```

```
*****
```

```
*
```

---

\*[Connection] BGA BGA 21

\*[Power Nets]

- \* 3 BGA\_VDD25 VDD25
- \* 4 BGA\_VDD25 VDD25
- \* 5 BGA\_VDD25 VDD25
- \* 6 BGA\_VDD25 VDD25
- \* 7 BGA\_VDD25 VDD25
- \* 8 BGA\_VDD25 VDD25
- \* 9 BGA\_VDD25 VDD25
- \* 19 BGA\_VDD125 VDD125
- \* 20 BGA\_VDD125 VDD125
- \* 21 BGA\_VDD125 VDD125

\*

\*[Ground Nets]

- \* 10 BGA\_GND2 GND
- \* 11 BGA\_GND2 GND
- \* 12 BGA\_GND2 GND
- \* 13 BGA\_GND2 GND
- \* 14 BGA\_GND2 GND
- \* 15 BGA\_GND2 GND
- \* 16 BGA\_GND2 GND
- \* 17 BGA\_GND2 GND
- \* 18 BGA\_GND2 GND

\*

\*[Signal Nets]

- \* 1 BGA\_1 DATA1
- \* 2 BGA\_2 DATA2

\*

\*[Connection] die die 6

\*[Power Nets]

- \* 1 die\_1 VDD25
- \* 6 die\_6 VDD125

\*

\*[Ground Nets]

- \* 2 die\_GND1 GND
- \* 5 die\_GND1 GND

\*

\*[Signal Nets]

- \* 3 die\_3 DATA1
- \* 4 die\_4 DATA2

```
*
*[MCP End]
*
*This concludes the MCP section
*Define the S element, the Model file is output from BNP

.MODEL Spara S
+          BNPPFILE = "C:\Program Files\Sigrity SpeedXP
8.1\PowerSI\Samples\psi_pkg_wb_pre-layout_032609_173742.bnp"

S
+          die_1          die_GND1
+          die_6          die_GND1
+          die_3          die_GND1
+          die_4          die_GND1
+          BGA_VDD25      BGA_GND2
+          BGA_VDD125     BGA_GND2
+          BGA_1          BGA_GND2
+          BGA_2          BGA_GND2
+          MNAME = Spara

*
.ENDS
*
*
```

## 5 How Sigrity Tools Generate MCP

This section introduces some guidelines used in Sigrity tools to generate MCP.

1. Always output the **[MCP Source]** section.

This section contains the tool name, the tool version, and the date when the model has been created in this section.

2. For the **[Connection]** *compName modelName totalNumberOfPin*:

- *compName* is the circuit name.
- *modelName* is the circuit model definition name.
- *totalNumberOfPins* is derived from the external node number if the model definition has external nodes, otherwise use the number of linkages instead.

3. **[Connection Type]** is optional.

If you are not sure about the connection type, skip this section.

4. How to choose pin names

- a. If the package node connects to one circuit node, use the circuit node as the pin name.
- b. If the package node connects to more than one circuit node or does not connect to any circuit node, use the pin field of the package node as the pin name.
- c. If the package node does not connect to any circuit node and does not have pin field either, create a unique name (number) as the pin name.